

Project No. 项目编号:
Sales 销售: Mandy wong
Approved By 核准:
Start Date 开案日期:
Tel 电话:

CTP 项目开发申请表

CTP Project Development Application FORM

请用中文或英文完整填写, 带有★的栏目为必须填写项目 Please fulfill in English or Chinese, column with ★ must be fulfilled

★Customer Company 客户公司名称:		★Applicant Company 申请公司名称:	
★Contact Person 项目联系人:		★Tel/E-mail 电话及邮箱:	
H/W Engineer(Tel/Email)硬件联系人:	S/W Engineer(Tel/Email)软件联系人:	Structural Engineer(Tel/Email)结构联系人:	
★Application Product 应用产品: CPU处理器:		Operating System 操作系统: Project Name 项目名称:	
预期首单数量/时间 Estimate pilot run QTY:		当年预测产量: annual QTY Total:	

Basic Specs& Requirements 产品基本规格及要求 Please fulfill in English or Chinese or mark as to choose.

★LCM 尺寸(LCM dimension): _____ ★LCM 分辨率(LCM resolution): _____ × _____

★触点数量(Number of touchpoint): _____ ★CTP 分辨率(CTP resolution): Match LCM (与 LCM 一致) User-defined 自定义 _____

★手势需求状况(Gesture requirements): _____

CTP 触点精度要求(CTP touchpoint accuracy): _____ 报点频率(Scan rates): _____ (一般为 60Hz, normally)

★LENS 类型(LENS type): Glass 玻璃 PET Others 其他 _____ (主要用玻璃, mainly is glass)

★LENS 厚度(LENS thickness): _____

★Sensor 尺寸(Sensor Dimension): _____

★Sensor (AA 区) 尺寸(AA block Dimension): _____ Sensor (VA 区) 尺寸(VA block Dimension): _____

★驱动 IC 位置(Driver IC in): FPCB Main board 主板 Others 其他 _____ (大部分在 FPC 上, mainly on FPC)

★是否含虚拟按键 (/数量) (Has virtual keys or not/ number): Yes 是 _____ 个(number) No 否

★虚拟按键实现方式: ITO FPCB(一般单键用 FPC 实现, 多键用 ITO 实现, Single key by FPC, multi keys by ITO)

★★元件区尺寸(Component area dimension): _____ 元件区在产品中的位置(Component area location in cell phone): _____

★★接口定义(Define of Interface) _____

★★接口信号电压(Interface signal voltage): 2.8V 3.3V 1.8V Others 其他 _____

★★接口形式(Interface format): I²C SPI USB Others 其他 _____

★★供电电压(Power voltage): 2.8V 3.3V 1.8V Others 其他 _____

★接口协议/中断方式(Interface Protocol/Interrupt mode defined by): Component Supplier 元件供应商制订 System Supplier 系统供应商制订

★ 待机方式(Sleep mode): Power off 断电 No power-off 非断电

保存温度范围(Storage temperature range): _____ 操作温度范围(Operating temperature range): _____

★ESD 要求 (空气) (ESD air requirement): _____ ★ESD 要求 (接触) (ESD contact requirement): _____

❖ If you need other items in this form, please specify 如需在表格内注明其他要求项, 请说明:

(Or to supply the enclosure named 或配附件, 附件名称: ***)

Project Schedule 项目计划 Please fill out the estimated starting date of each process.请在以下栏目填写各环节的预计开始日期

	项目启动 Kickoff	设计布线 Design/Layout	模组测试 Module Tuning	系统联调 System Verification	试产 Pilot Production	量产 Mass Production
For Applicant 申请人填写						
For sales 销售人员确认						

Remark 备注

- 1, 提供开发申请表时同时需提供 CAD 格式结构图- Release CAD structure drawing together with this form
- 2, 结构图中需标明接口定义及 AA 区/VA 区等相关尺寸—Define of interface and AA/VA dimensions in details should be covered in the structure drawing.
- 3, 有异议的或未尽事宜双方再另行沟通—Further discussion needed if any.